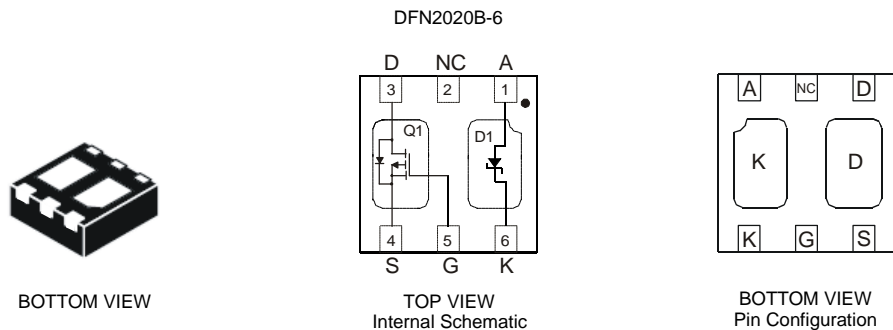


Features

- Low On-Resistance
 - 95mΩ @V_{GS} = -4.5V
 - 120mΩ @V_{GS} = -2.5V
 - 86mΩ (typ) @V_{GS} = -1.8V
- Low Gate Threshold Voltage, -1.3V Max
- Fast Switching Speed
- Low Input/Output Leakage
- Incorporates Low V_F Super Barrier Rectifier (SBR[®])
- Low Profile, 0.5mm Max Height
- Lead Free/RoHS Compliant (Note 2)
- "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: DFN2020B-6
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminal Connections: See Diagram
- Terminals: Finish – NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 6
- Ordering Information: See Page 6
- Weight: 0.0065 grams (approximate)



Maximum Ratings – TOTAL DEVICE @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1)	P _D	1.4	W
Thermal Resistance, Junction to Ambient	R _{θJA}	89	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Maximum Ratings – P-CHANNEL MOSFET – Q1 @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Units
Drain-Source Voltage	V _{DSS}	-20	V
Gate-Source Voltage	V _{GSS}	±12	V
Drain Current (Note 1)	I _D	-3.5	A
Pulsed Drain Current (Note 4)	I _{DM}	-12	A

Maximum Ratings – SBR[®] – D1 @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _R RM	35	V
Working Peak Reverse Voltage	V _R WM		
DC Blocking Voltage	V _R		
RMS Reverse Voltage	V _{R(RMS)}	25	V
Average Rectified Output Current	I _O	1	A
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	3	A

- Notes:
1. Device mounted on FR-4 PCB, on minimum recommended, 2oz Copper pad layout.
 2. No purposefully added lead.
 3. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
 4. Repetitive rating, pulse width limited by junction temperature.

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Electrical Characteristics – P-CHANNEL MOSFET – Q1 @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 5)						
Drain-Source Breakdown Voltage	BV_{DSS}	-20	—	—	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	I_{DSS}	—	—	-1	μA	$V_{DS} = -20V, V_{GS} = 0V$
Gate-Source Leakage	I_{GSS}	—	—	± 100 ± 800	nA	$V_{GS} = \pm 8V, V_{DS} = 0V$ $V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 5)						
Gate Threshold Voltage	$V_{GS(th)}$	-0.45	—	-1.3	V	$V_{DS} = V_{GS}, I_D = -250\mu A$
Static Drain-Source On-Resistance	$R_{DS(ON)}$	—	60	95	m Ω	$V_{GS} = -4.5V, I_D = -2.8A$
		—	74	120		$V_{GS} = -2.5V, I_D = -2.0A$
		—	86	—		$V_{GS} = -1.8V, I_D = -1.0A$
		—	—	—		
Forward Transfer Admittance	$ Y_{fs} $	—	8	—	S	$V_{DS} = -5V, I_D = -2.8A$
Diode Forward Voltage (Note 5)	V_{SD}	—	0.7	-1.2	V	$V_{GS} = 0V, I_S = -1.6A$
DYNAMIC CHARACTERISTICS						
Input Capacitance	C_{iss}	—	632	—	pF	$V_{DS} = -10V, V_{GS} = 0V$ $f = 1.0MHz$
Output Capacitance	C_{oss}	—	65	—	pF	
Reverse Transfer Capacitance	C_{rss}	—	54	—	pF	

Electrical Characteristics – SBR[®] – D1 @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	$V_{(BR)R}$	35	40	—	V	$I_R = 1mA$
Forward Voltage	V_F	—	354	0.42	V	$I_F = 0.5A$
		—	415	0.49		$I_F = 1.0A$
Reverse Current (Note 5)	I_R	—	—	100	μA	$V_R = 20V$

Notes: 5. Short duration pulse test used to minimize self-heating effect.

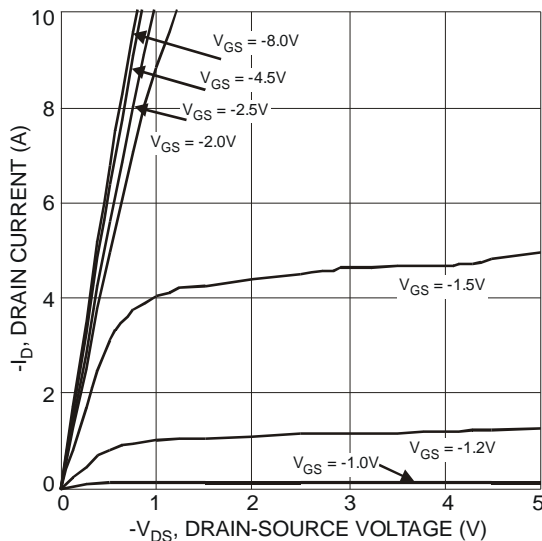
Q1, P-CHANNEL MOSFET


Fig. 1 Typical Output Characteristics

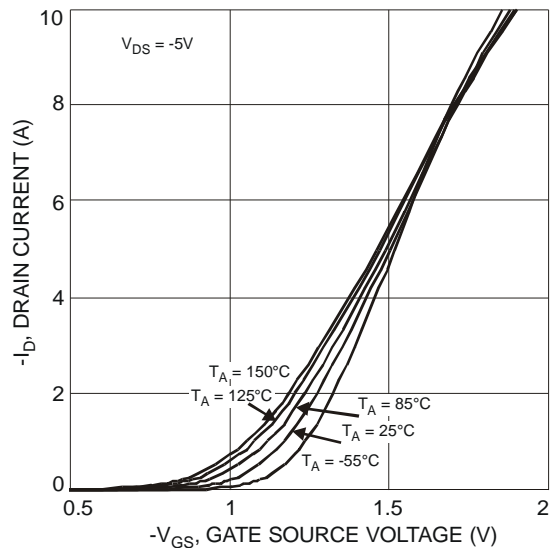


Fig. 2 Typical Transfer Characteristics

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Q1, P-CHANNEL MOSFET - Continued

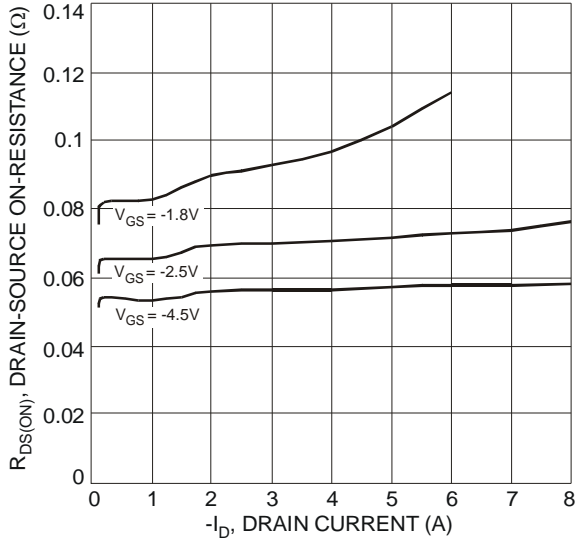


Fig. 3 Typical On-Resistance vs. Drain Current and Gate Voltage

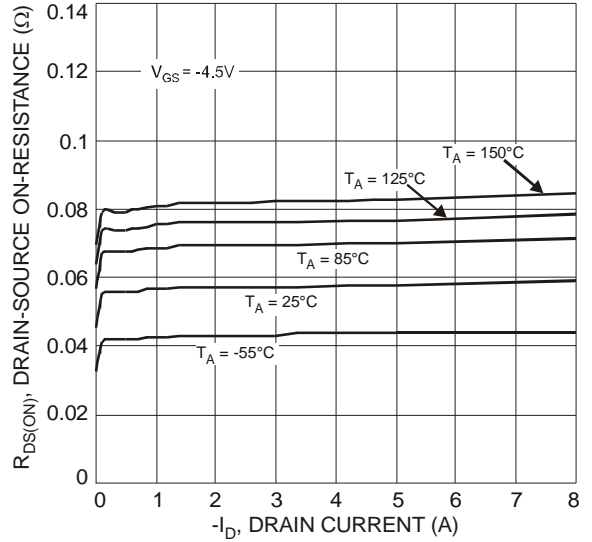


Fig. 4 Typical Drain-Source On-Resistance vs. Drain Current and Temperature

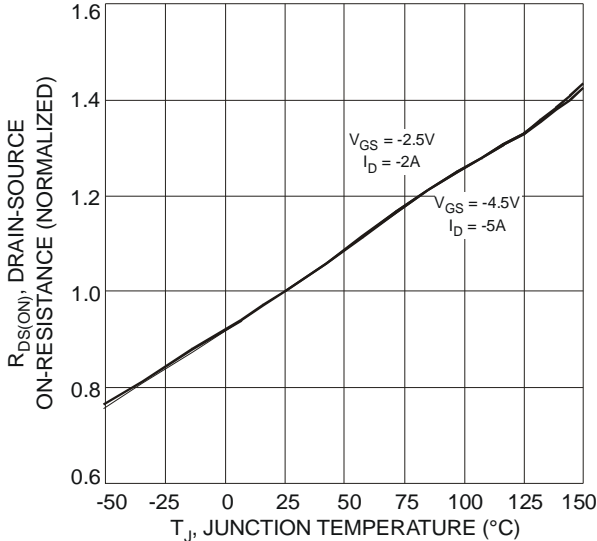


Fig. 5 On-Resistance Variation with Temperature

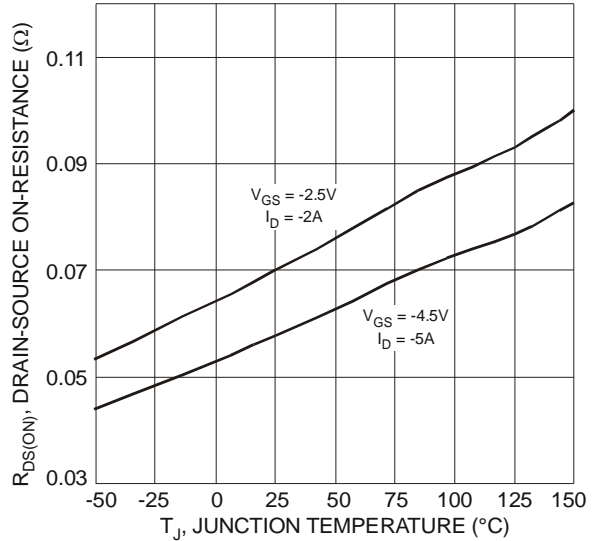


Fig. 6 On-Resistance Variation with Temperature

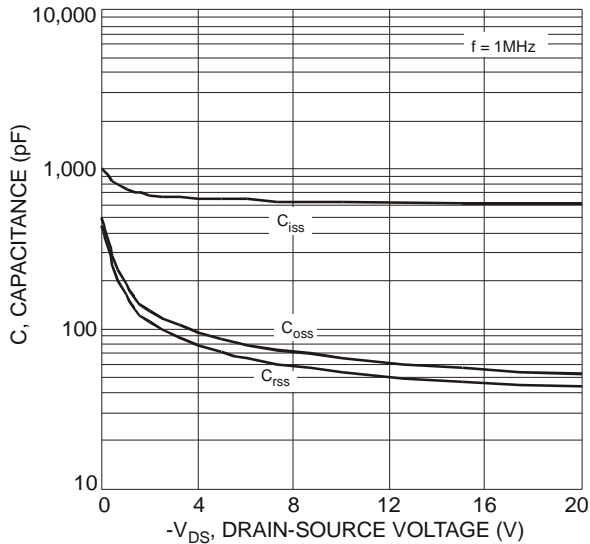


Fig. 7 Typical Capacitance

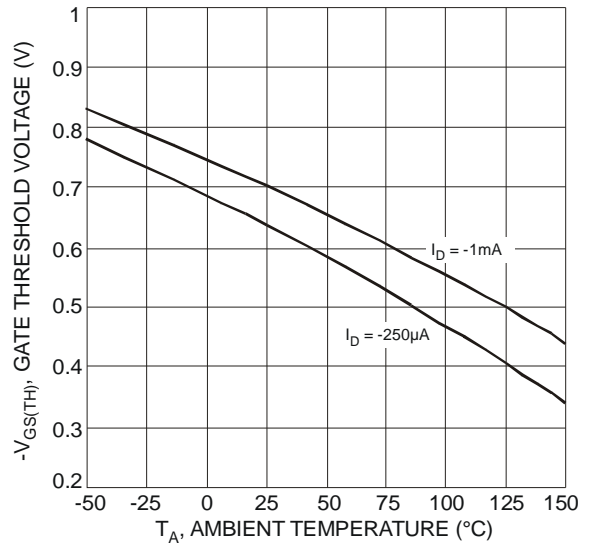


Fig. 8 Gate Threshold Variation vs. Ambient Temperature

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Q1, P-CHANNEL MOSFET - Continued

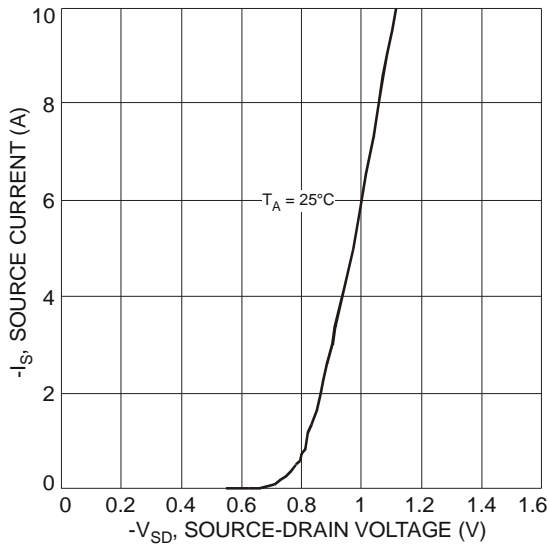


Fig. 9 Diode Forward Voltage vs. Current

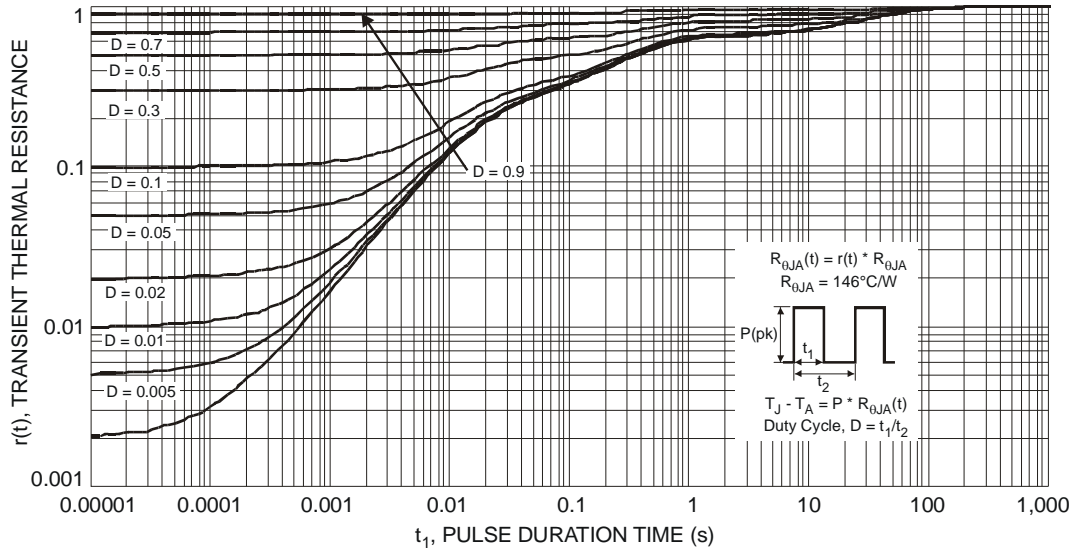


Fig. 10 Transient Thermal Response

D1, SBR®

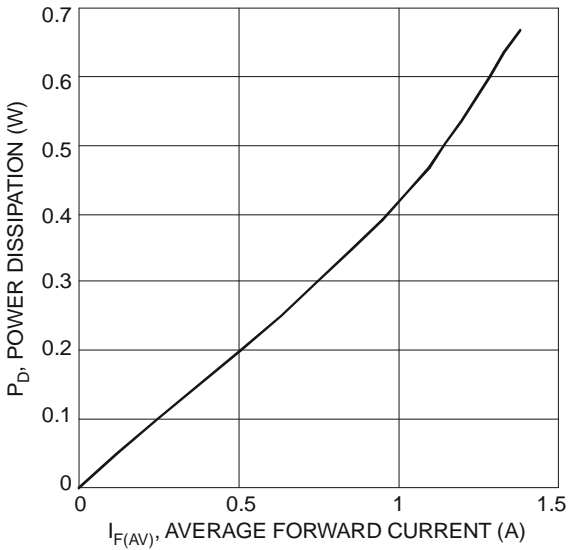


Fig. 11 Forward Power Dissipation

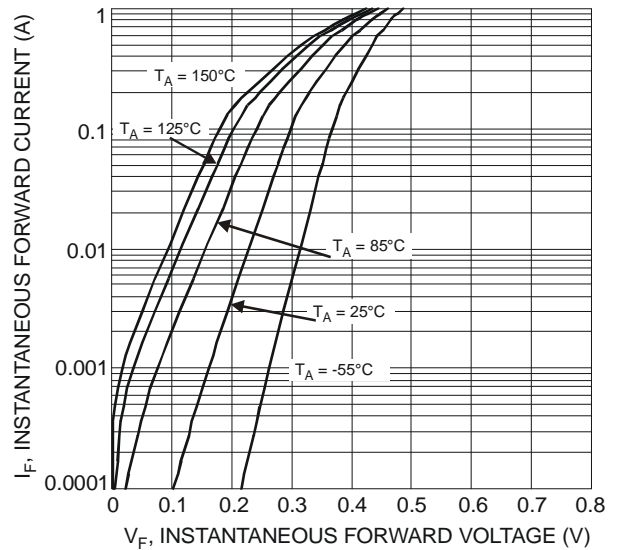


Fig. 12 Typical Forward Characteristics

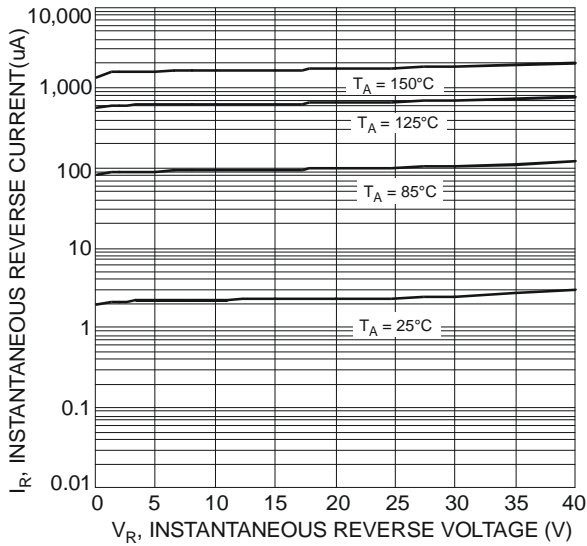


Fig. 13 Typical Reverse Characteristics

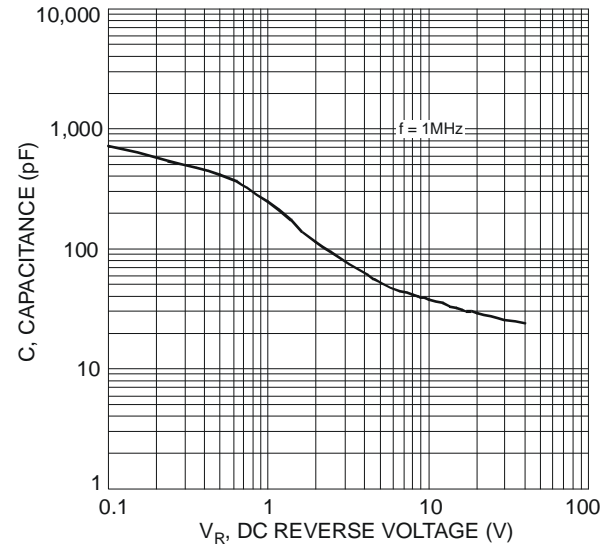


Fig. 14 Total Capacitance vs. Reverse Voltage

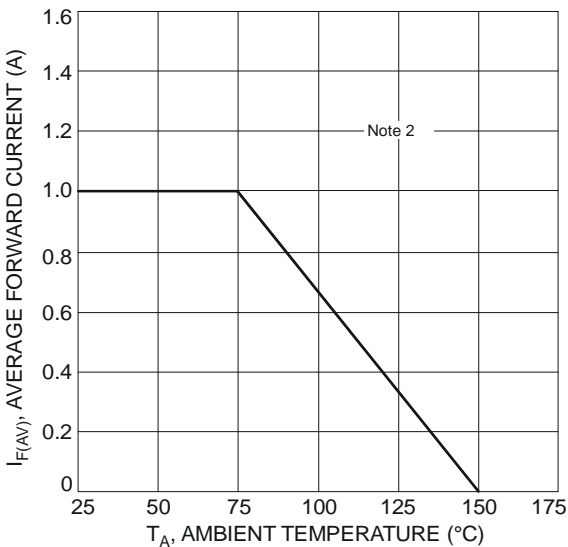


Fig. 15 Forward Current Derating Curve

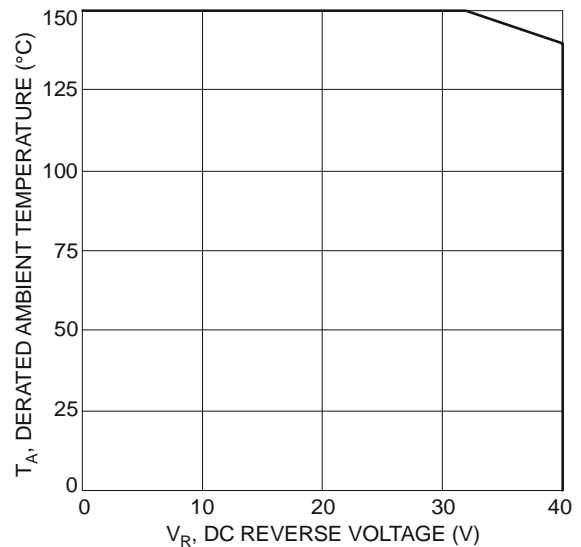


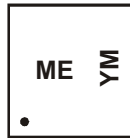
Fig. 16 Operating Temperature Derating

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Ordering Information (Note 6)

Part Number	Case	Packaging
DMS2220LFDB-7	DFN2020B-6	3000/Tape & Reel

Notes: 6. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

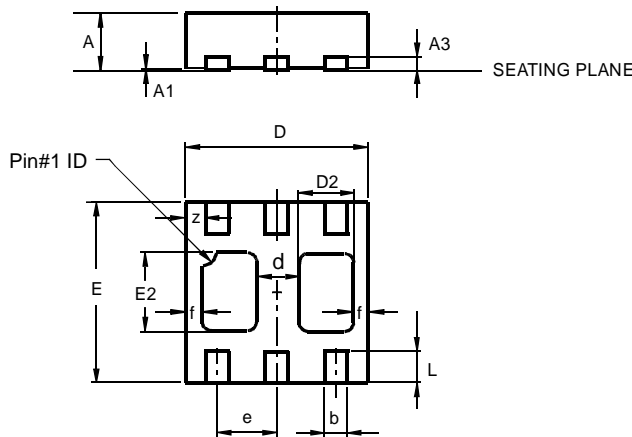
Marking Information


ME = Marking Code
 YM = Date Code Marking
 Y = Year (ex: V = 2008)
 M = Month (ex: 9 = September)
 Dot denotes Pin 1

Date Code Key

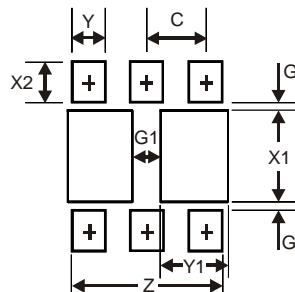
Year	2008	2009	2010	2011	2012	2013	2014	2015
Code	V	W	X	Y	Z	A	B	C

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Package Outline Dimensions


DFN2020B-6			
Dim	Min	Max	Typ
A	0.545	0.605	0.575
A1	0	0.05	0.02
A3	—	—	0.13
b	0.20	0.30	0.25
D	1.95	2.075	2.00
d	—	—	0.45
D2	0.50	0.70	0.60
e	—	—	0.65
E	1.95	2.075	2.00
E2	0.90	1.10	1.00
f	—	—	0.15
L	0.25	0.35	0.30
z	—	—	0.225

All Dimensions in mm

Suggested Pad Layout


Dimensions	Value (in mm)
Z	1.67
G	0.20
G1	0.40
X1	1.0
X2	0.45
Y	0.37
Y1	0.70
C	0.65

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1. are intended to implant into the body, or
2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

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